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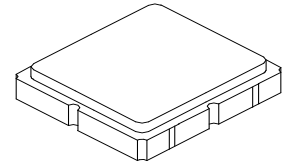
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# RF2040E

## 915.0 MHz SAW Filter



SM3030-8

- **Designed for 902.0 - 928.0 MHz Applications**
- **Optimized for use with the TRC103 Transceiver**
- **Balanced 150 ohm IC Interface**
- **Complies with Directive 2002/95/EC (RoHS)** 

### Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	+15	dBm
DC Voltage	±5	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Soldering Temperature (10 seconds / 5 cycles maximum)	260	°C

### Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	$f_c$			915.0		MHz
1 dB Bandwidth	$BW_1$			31		MHz
Maximum Insertion Loss, 902.0 to 928.0 MHz	$IL_{MAX}$			2.0	3.0	dB
Amplitude Ripple, p-p, 902.0 to 928.0 MHz				0.7	1.0	
Rejection Referenced to Insertion Loss at 915.0 MHz:						
710 to 810 MHz			37	40		
810 to 860 MHz			37	40		
1010 to 1060 MHz			37	40		
1060 to 1110 MHz			43	45		
1110 to 1210 MHz			45	48		
Source Impedance	$Z_S$			50		$\Omega$
Load Impedance	$Z_L$			130		$\Omega$

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	804, YWWS					
Standard Reel Quantity	Reel Size 7 Inch					1000 Pieces/Reel
	Reel Size 13 Inch					3000 Pieces/Reel

### Electrical Connections

Connection	Terminals
Single-ended Port	6
Balanced Port	1, 3
Case Ground	4, 5, 7, 8
No Connection	2

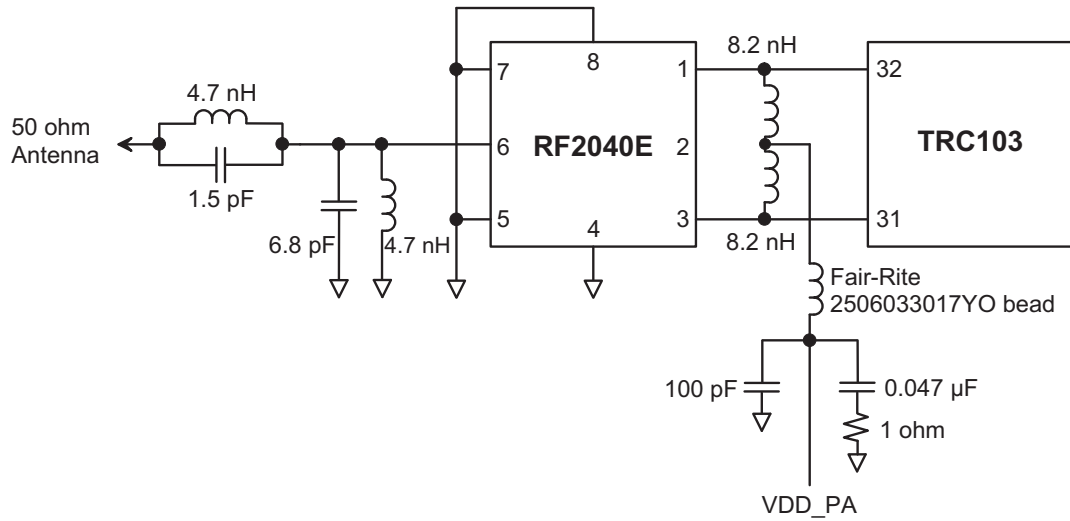


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

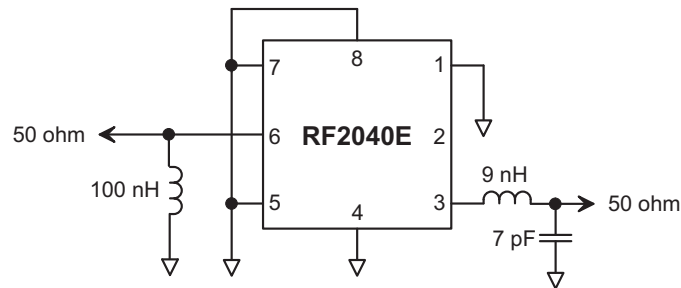
#### NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency,  $f_c$ .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. The design, manufacturing process, and specifications of this filter are subject to change.
5. US and international patents may apply.
6. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

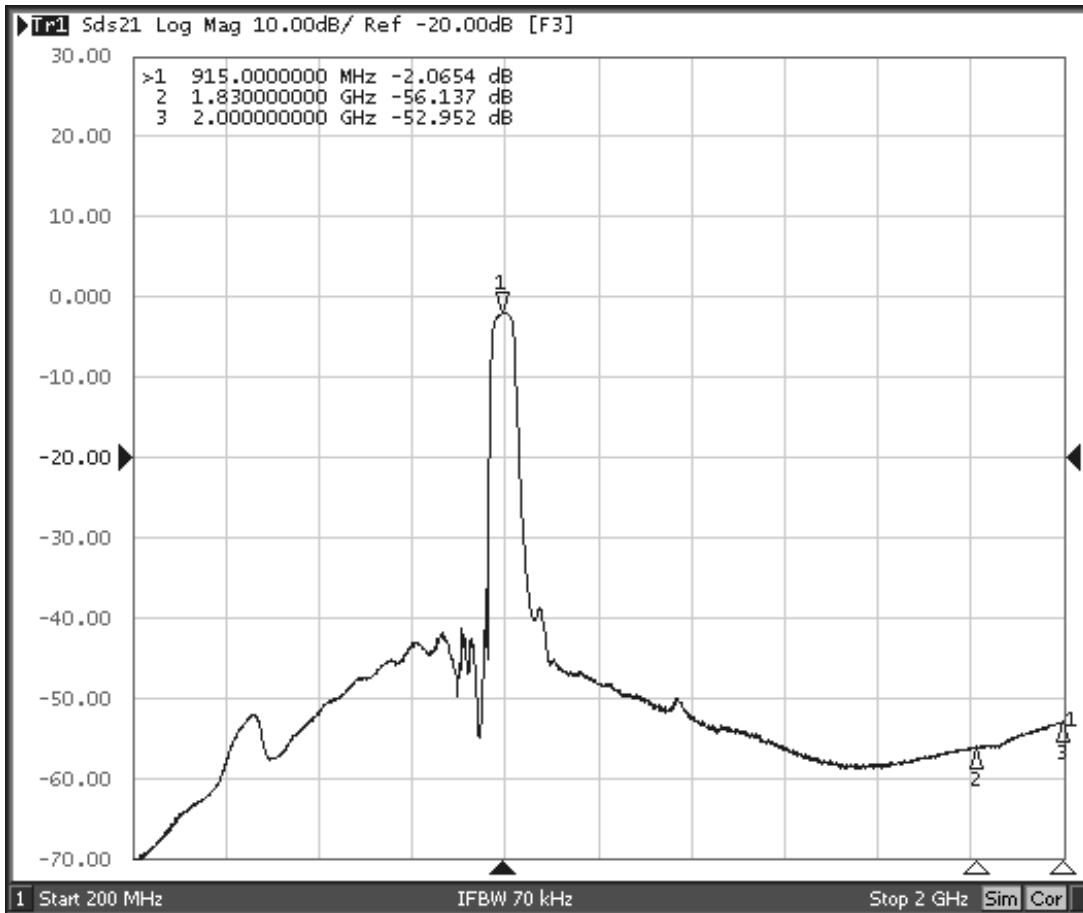
## RF2040E-TRC103 Application Circuit



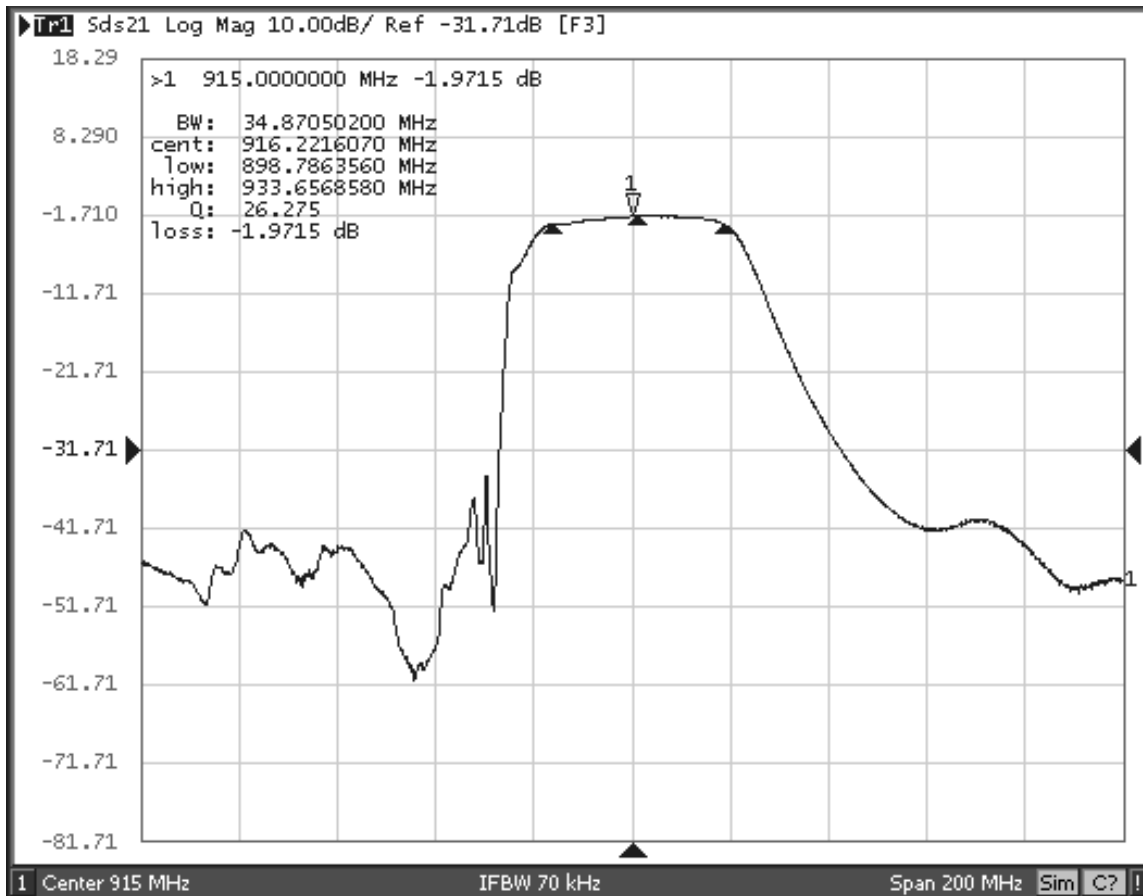
## RF2040E 50 Ohm Tuning Network



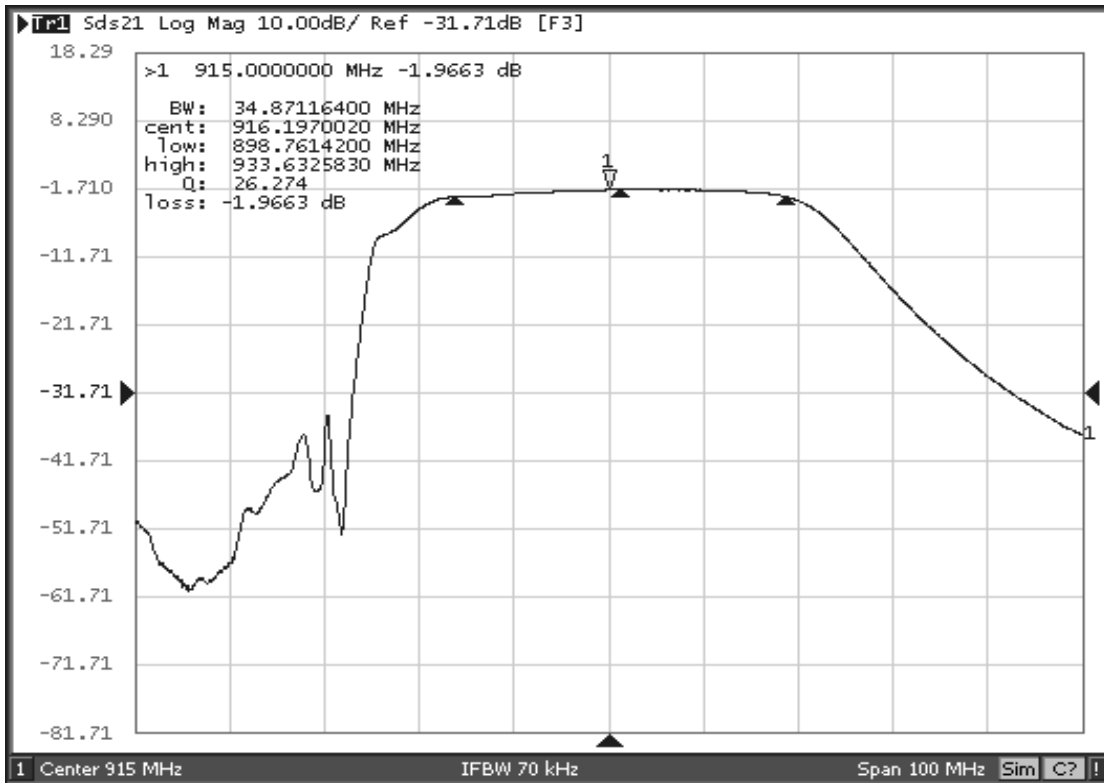
# RF2040E Broadband Response, 200 to 2000 MHz



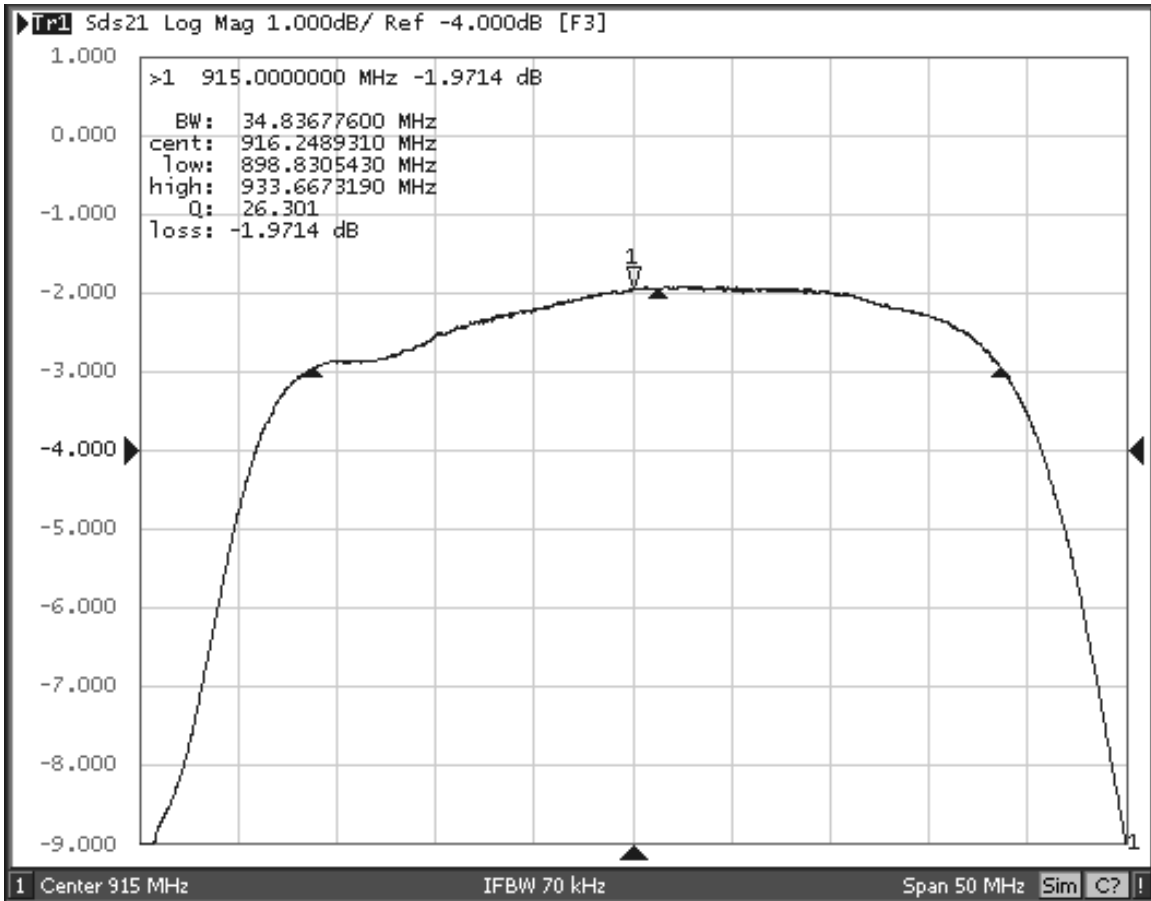
## RF2040E Response, 815.0 to 1015.0 MHz



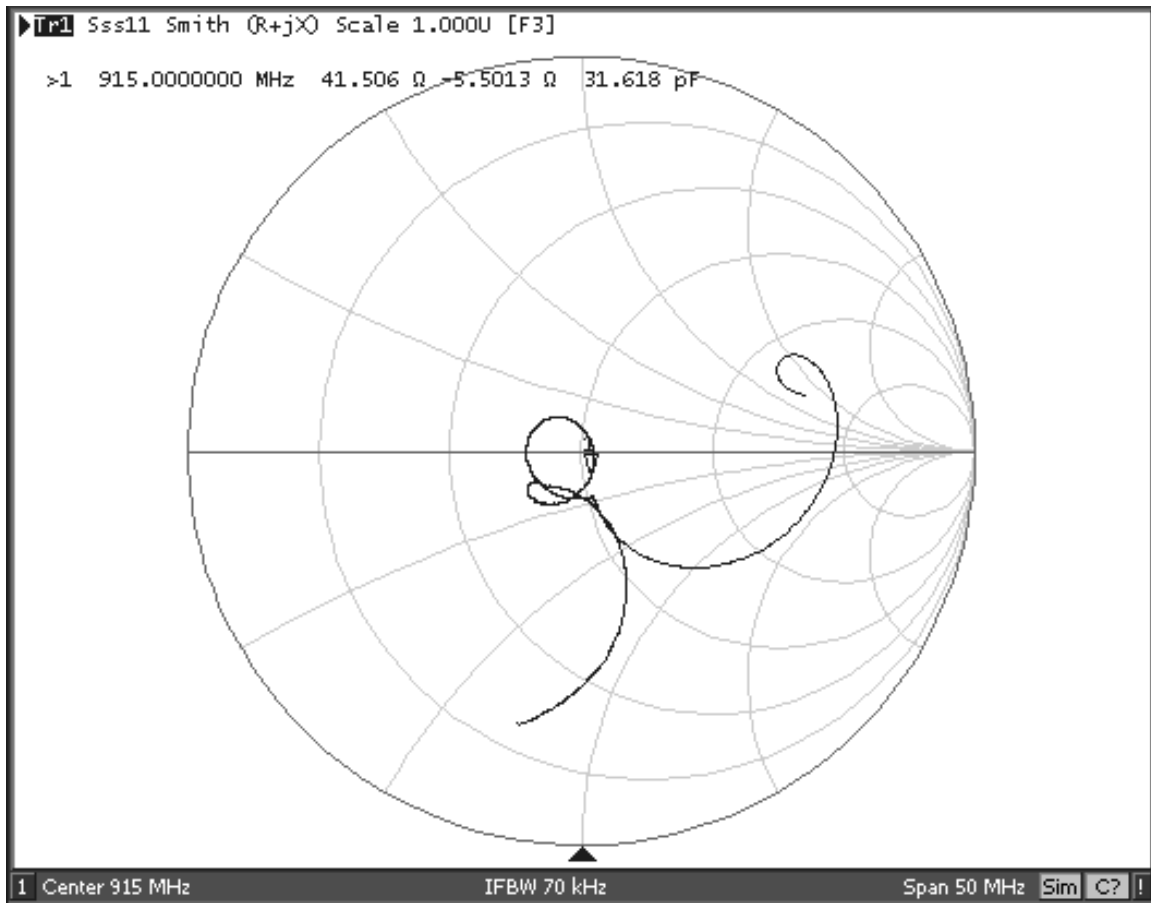
# RF2040E Response, 865.0 to 965.0 MHz



# RF2040E Passband Response

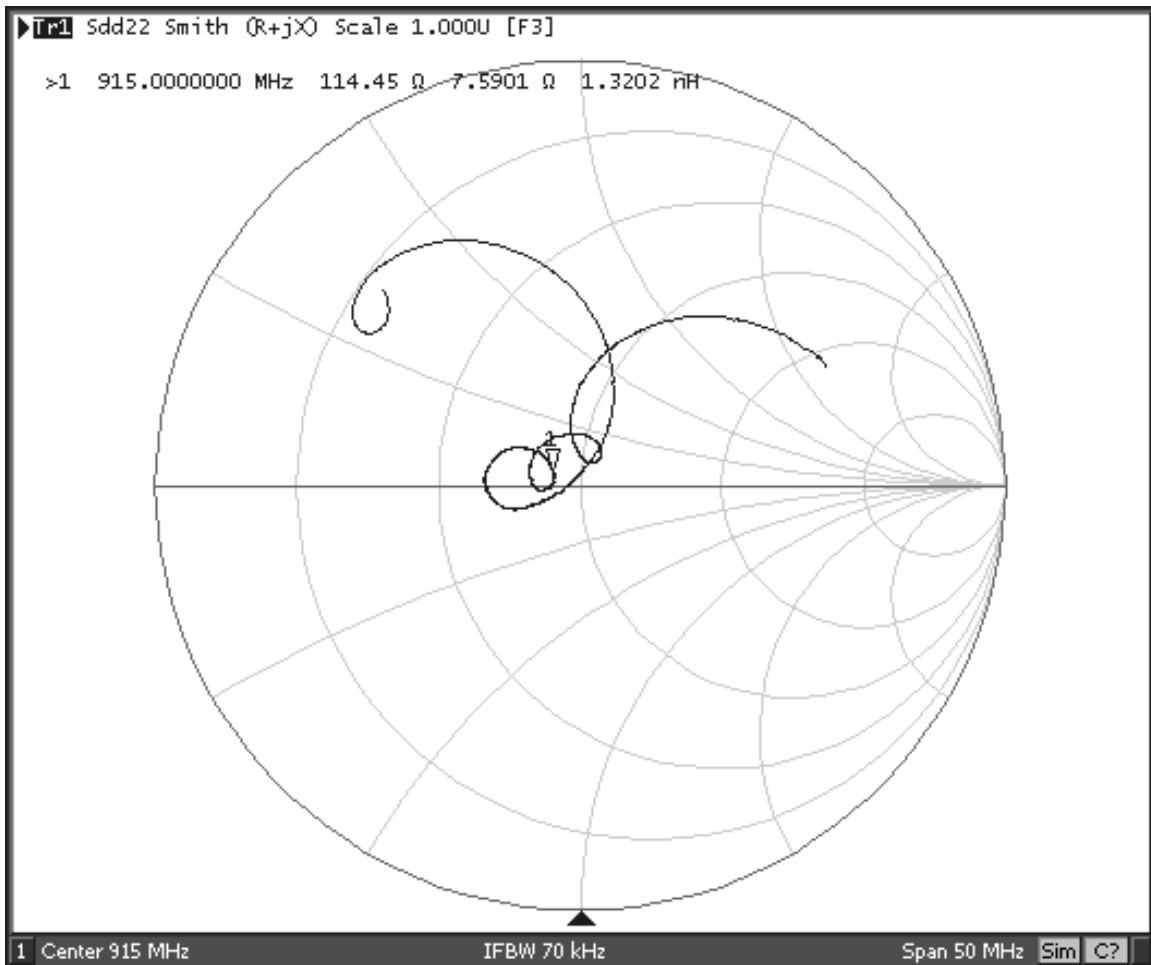


## RF2040E Input Impedance Plot

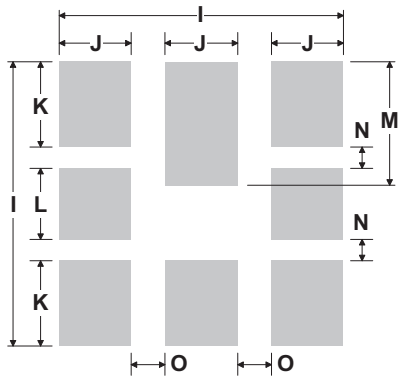
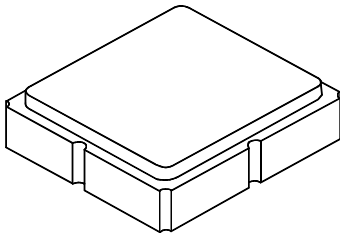




## RF2040E Balanced Output Impedance Plot



## 8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



**PCB Footprint Top View**

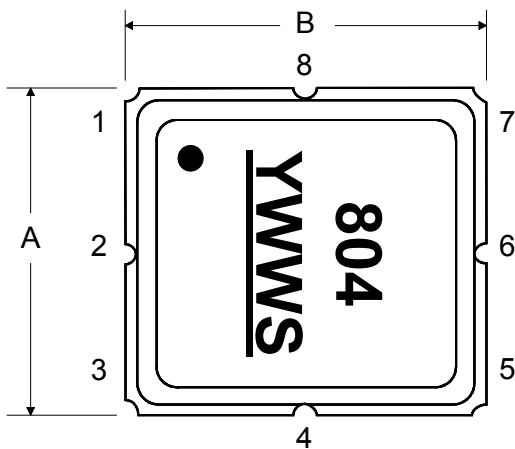
### Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.0	3.13	0.113	0.118	0.123
B	2.87	3.0	3.13	0.113	0.118	0.123
C	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
M		1.39			0.055	
N		0.23			0.009	
O		0.38			0.015	

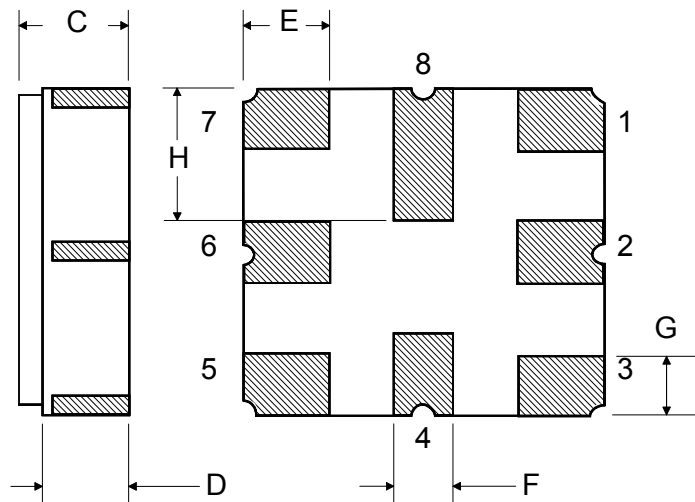
### Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	

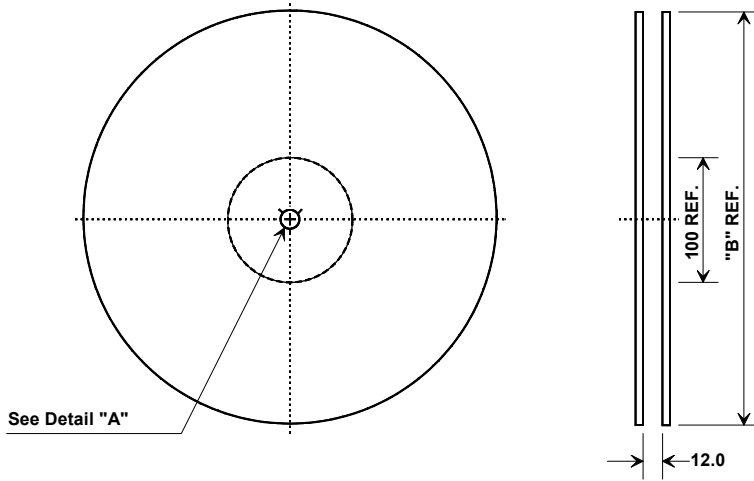
**TOP VIEW**



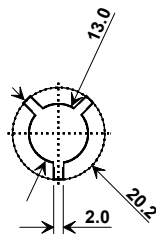
**BOTTOM VIEW**



# Tape and Reel Specifications



"B "		Quantity Per Reel
Inches	millimeters	
7	178	1000
13	330	3000



Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.4 mm
Pitch	8.0 mm
W	12.0 mm

## COMPONENT ORIENTATION and DIMENSIONS

